

APPROVAL SHEET

SMD ANTENNA

RFANT Series – RoHS Compliance

2.4 GHz ISM Band Working Frequency

P/N: RFANT3216120A5T Series

*Contents in this sheet are subject to change without prior notice.



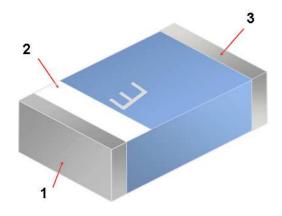
FEATURES

- 1. Surface Mounted Devices with a small dimension of 3.2 X 1.6 X1.2 mm³ meet future miniaturization trend.
- 2. LTCC process
- 3. High stability in Temperature / Humidity Change

APPLICATIONS

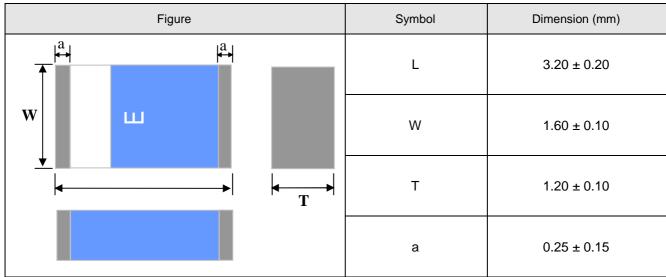
- 1. 2.4GHz ISM band RF applications
- 2. Bluetooth, Wireless, HomeRF

CONSTRUCTION



- 1. Feeding
- 2. Identification Mark
- 3. Soldering terminal

DIMENSIONS



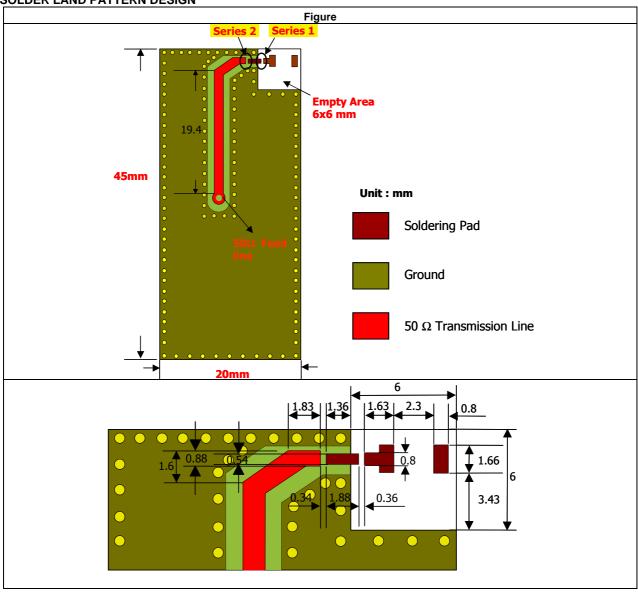


ELECTRICAL CHARACTERISTICS

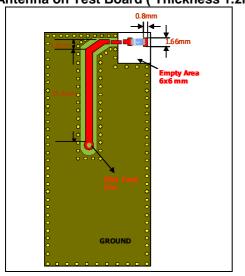
RFANT3216120A5T		Specification	
Working Frequenc	y Range	2450 ± 50 MHz	
Fc (GHz)		2.9	
Gain (dBi)		2.12dBi(Typical)	
VSWR		2 max.	
Matching component value	Series 1	6.8nH	
matching component value	Series 2	-	
Operation Temperature		-40°C ~ +85°C	

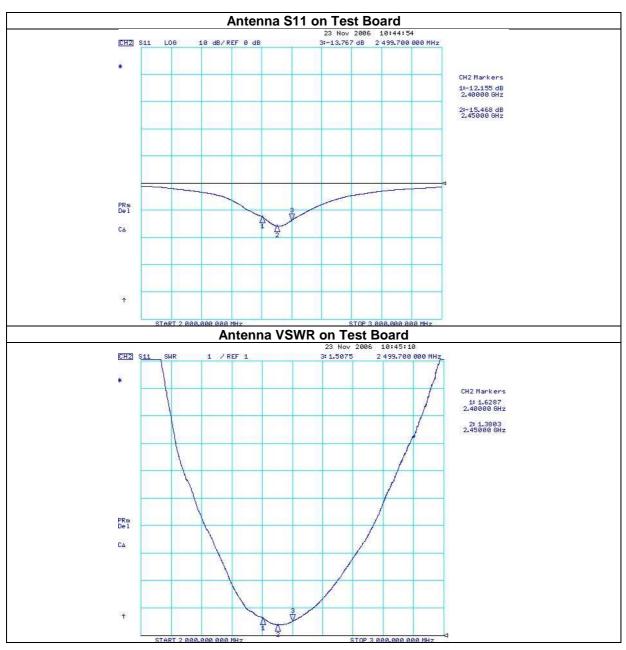
^{*} This frequency must be adjusted to 2.45GHz with matching circuit.

SOLDER LAND PATTERN DESIGN







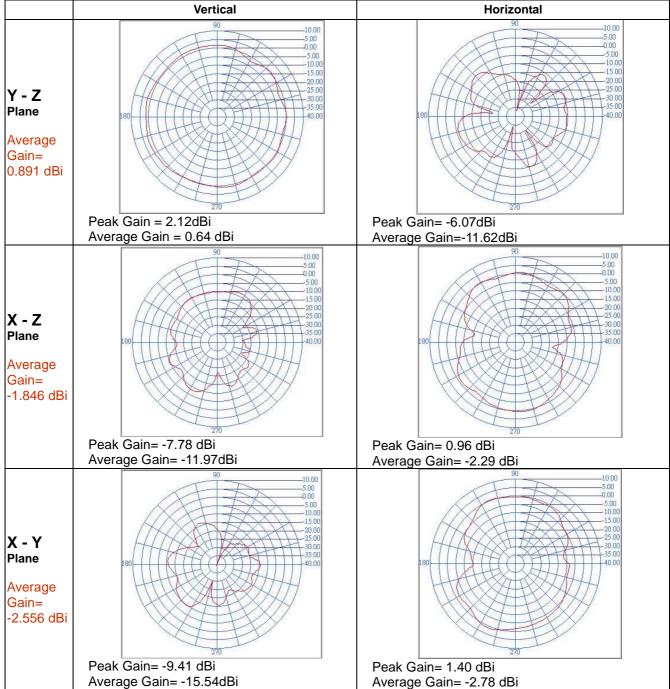




RADIATION PATTERN

Radiation Pattern and Gain were dependent on measurement board design. The specification of RFANT3216120A5T antenna was measured based on the PCB size and installation position as shown in the below figure Test Board







RELIABILITY TEST

Test item	Test condition / Test method	Specification	
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5^{\circ}$ C *Immersion time : 2 ± 0.5 sec	At least 95% of a surface of each terminal electrode must be covered by fresh solder.	
323022-61020	*Solder : Sn3Ag0.5Cu for lead-free		
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : $30 \pm 0.5 \text{ sec}$ *Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.	
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : 120~150°C, 1 minute. *Solder temperature : 270±5°C *Immersion time : 10±1 sec *Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test. Loss of metallization on the edges of each electrode shall not exceed 25%.	
Drop Test JIS C 0044	*Height: 75 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units; 2 times for each side.	after test.	
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N(≤0603) ; 10N(>0603) *Test time : 10±1 sec	No remarkable damage or removal of the termination.	
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours	No mechanical damage. Samples shall satisfy electrical specification after test.	

Temperature cycle	1 00.0 1 1 10.0.00		
JIS C 0025	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.	
0.0 0 0020	2. 10~15 minutes at room temperature,	Samples shall satisfy electrical specification	
	3. 30±3 minutes at +85°C±3°C,	after test.	
	4. 10~15 minutes at room temperature,		
	Total 100 continuous cycles		
	Measurement to be made after keeping at		
	room temperature for 24±2 hrs		
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.	
JIS C 0040	*Total amplitude: 1.5mm	Samples shall satisfy electrical specification	
	*Test times : 6hrs.(Two hrs each in three	after test.	
	mutually perpendicular directions)		
High temperature		No machanical damana	
JIS C 0021	*Temperature : 85°C±2°C	No mechanical damage.	
	*Test duration: 1000+24/-0 hours	Samples shall satisfy electrical specification after test.	
	Measurement to be made after keeping at	alter test.	
	room temperature for 24±2 hrs		
Humidity	*Humidity: 90% to 95% R.H.	No mechanical damage.	
(steady conditions)	*Temperature : 40±2°C	Samples shall satisfy electrical specification	
JIS C 0022	*Time: 1000+24/-0 hrs.	after test.	
	Measurement to be made after		
	keeping at room temperature for 24±2		
	hrs		
Low temperature	*Temperature : -40°C±2°C	No mechanical damage.	
JIS C 0020		Samples shall satisfy electrical specification	
	*Test duration: 1000+24/-0 hours	after test.	
	Measurement to be made after keeping at		
	room temperature for 24±2 hrs		

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2

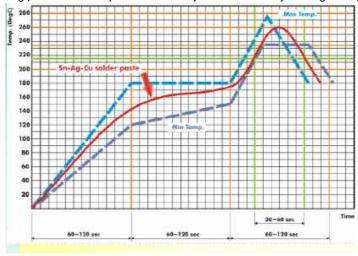


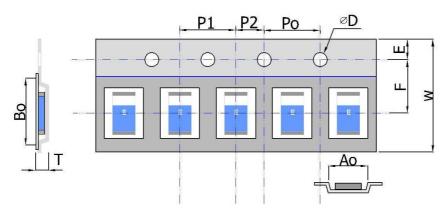
Fig 2. Infrared soldering profile

ORDERING CODE

RF	ANT	321612	0	Α	5	Т
Walsin	Product	Dimension code	Unit of	Application	Specification	Packing
RF device	code	Per 2 digits of	dimension	A: 2.4GHZ ISM	Design Code	T:7" Reeled
	ANT :	Length, Width,	0 : 0.1 mm	Band		
	Antenna	Thickness :	1 : 1.0 mm			
		e.g. :				
		321612 =				
		Length 32,				
		Width 16,				
		Thickness 12				

Minimum Ordering Quantity: 2000 pcs per reel.

PACKAGING

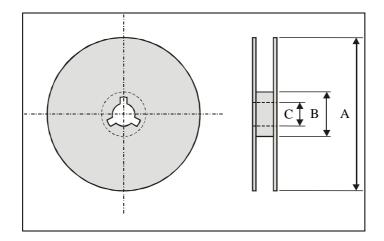


Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	T	W
Dimension (mm)	1.95 ± 0.10	3.45 ± 0.10	1.55 ± 0.05	1.30 ± 0.10	8.20 +0.10
					-0.30
Index	Е	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10



Reel dimensions



Index	А	В	С
Dimension (mm)	Φ178	Φ60.0	Ф13.5

Typing Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to +40 $^{\circ}$ C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.